

Secure Oregon's Premier Engineering Talent through MECOP Internships

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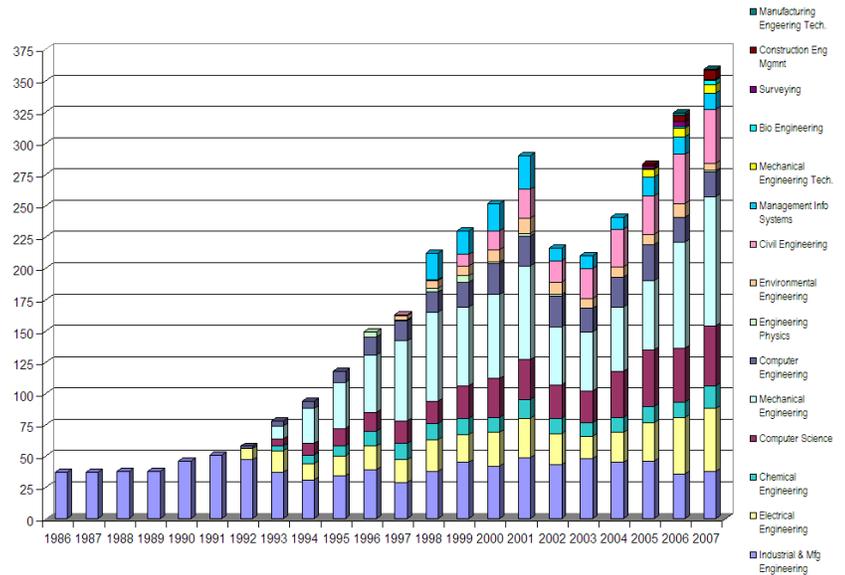


MECOP & Intel – A Program Overview

MECOP (Multiple Engineering Cooperative Program) is a unique internship alliance driven collaboratively by Oregon's Engineering Universities (OSU, PSU, & OIT), their respective student bodies, and Industry Partners of which Intel has been a member since 1981. MECOP has thrived from its inception at OSU in 1978 and now annually places over 350 interns in **6 month** engineering internships across 75 of Oregon's top engineering companies. Intel continues to be a cornerstone of MECOP's engineering successes by annually employing up to 50 interns with the majority of Intel's internship disciplines being electrical, mechanical, and computer engineering.

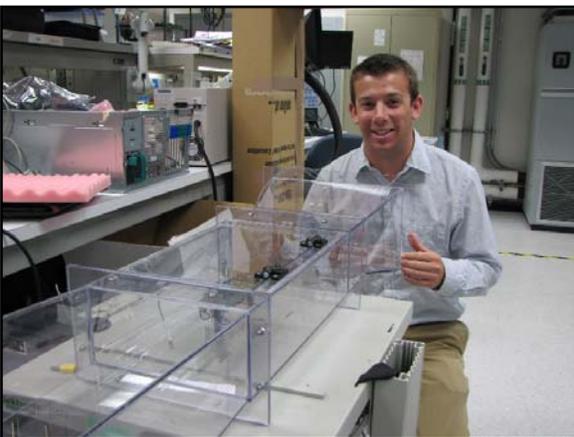
So what makes MECOP Unique?

- Students have 2 internships in diverse industries during their junior/senior years.
- 6 month vs. traditional 3 month internships.
- University led pre-screening process ensures top candidates.
- Partnership between industry and academia drive student preparation for challenging internship opportunities.
- Strong networking between MECOP graduates and Northwest companies.



2007 MECOP Testimonials

David Lane is a senior from OSU studying to be a Mechanical Engineer. He was selected from the MECOP program by the LAD NIC Operations group, with the objective of: Defining shock failures in development and developing a wind tunnel for thermal testing. "It is a win-win for both sides because the intern gets a better understanding of what to expect after college and the company gets an educated, highly motivated intern" LNO Team Leader Dave Capwell comments. We asked David what his most exciting project was during his MECOP internship: "When I built a wind tunnel out of cardboard and duct tape". That wind tunnel was designed, modeled in Solid Works® and Flotherm®, and manufactured within 2 days to meet a critical customer's needs. Capwell also stated, "The MECOP program is well organized and has provided our team with qualified, well rounded students that have been able to complete projects on time with high quality."



Chantelle Hanson is a Junior from PSU also studying to be a Mechanical Engineer. Chantelle works in TMG in the SMTD / BPI Group (Systems Manufacturing Technology Development / Board Platform Integration) where her main project over her 6 month internship is to assist in the second

level interconnect validation of the McCreary Desktop Platform. Doin Davenport manages the BPI Team which owns platform second level interconnect validation, the group in which Chantelle works. Davenport comments, "SMTD/BPI has participated in MECOP for the past five years. MECOP Interns have resolved a myriad of issues related to specific component manufacturability and reliability and have repeatedly proven themselves as valuable team contributors."



For more information: Contact the Program Director, Gary Petersen, by email at gary.p.petersen@oregonstate.edu or by telephone at (541) 737-3210.